# MICHAEL J. PARK

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# **EDUCATION**

# University of Texas at Austin

December 2016

BS, Electrical and Computer Engineering

Senior Project: Batteryless and Wireless Data Acqusition Implant and System

GPA: 3.61/4.0

# **EXPERIENCES**

#### Academic

## University of Texas at Austin

May 2016 - December 2016

Austin, TX

Undergraduate Research Assistant

- Wrote a literature review on deep learning applications in the embedded domain
- · Evaluated open-source neural network libraries on embedded platforms to collect preliminary data
- · Explored electronic system-level design

# Keimyung University

May 2013 - August 2013, May 2014 - August 2014

Daegu, South Korea

Undergraduate Research Assistant

- $\cdot$  Fabricated a thermocouple based distributed temperature sensor
- · Designed and tested a bridge circuit based platinum temperature sensor
- · Analyzed data of the temperature sensors

## Industry

#### MKS Instruments

January 2015 - November 2015

Austin, TX

Embedded Software Co-op

- · Created an automated test framework for testing EtherCAT, Modbus TCP, and RS-232 protocols
- · Ported EtherCAT module into a bootloader to enable TFTP for loading application on an embedded device
- · Added restoration and debugging features in a bootloader to support testing DDR memory on an embedded device
- $\cdot$  Wrote and trouble shooted embedded software applications for different devices
- · Modified an embedded web server API using JSON and RESTful architecture
- · Tested latency, performance, and interoperability of embedded nodes on a CAN network
- · Supported internal customers

# PUBLICATION & PATENT

#### **Journal**

1) Jaehee Park, Michael Jin Park, and Dohyun Ahn, "Thermocouple-Based Distributed Temperature Sensor", International Journal of Electrical and Electronics Engineering Research(IJEEER), vol.6, no.4, pp 69-74, 2016.

# Patent

1) J. Park, M. Kim, J. Kim, M. Park, and Jae-Cheon Lee, Distribution-Type Thermocouple Sensor and Thermocouple-Based Distribution-Type Temperature Measurement System Using Same, PCT/KR2014/004318, 2014.

## AWARD & ACHIEVEMENTS

# 1st Place - NXP Cup Challenge 2016 (Amateur Division)

- · Wrote an embedded software for an autonomous model car to participate in a race
- · Designed and tested an image-based PID control algorithm used to navigate our model car

## 1st Place – Honors Senior Design Competition Fall 2016 (UT ECE)

- · Developed a batteryless data acquisition implant that communicates through an induction coil
- · Built a system around the implant that allows users to control the implant through a web application
- · Primarily contributed to developing the embedded software and testing the full system

# Member – HKN (ECE Honor Society) Since Spring 2015

· Satisfied honors and pledge requirements

# TECHNICAL SKILLS

Languages C/C++, Python, MATLAB/OCTAVE, ASM(ARM, MIPS), VHDL/Verilog, Java, LaTeX

Platforms Raspberry Pi, Odroid, TI(TM4C, RF430FRL), AVR(ATmega128)

OS Linux, Android, Windows

# RELEVANT COURSEWORKS

UT Austin

Real-Time Operating Systems, Computer Architecture, Digital Systems Design Using HDL,

Embedded Systems Design Lab, Real-Time Digital Signal Processing Lab,

Algorithms, Data Structures, C/C++ Programming,

Probability and Random Processes, Electromagnetic Engineering

MOOC

Machine Learning by Stanford University on Coursera, Control of Mobile Robots by Georgia Tech on Coursera

# LANGUAGES

English Native or Bilingual Proficiency
Korean Native or Bilingual Proficiency

Japanese Elementary Proficiency